

## Electrical Properties of Oriented SnO<sub>2</sub> Thin Films

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*Electrical properties of (001) and (110) oriented SnO<sub>2</sub> films with SnO<sub>2</sub> crystallites oriented in the same direction as the rutile TiO<sub>2</sub> substrates, were investigated. The oriented films exhibited relatively low electric conductivities of 10<sup>-2</sup>-10<sup>1</sup> Scm<sup>-1</sup> (carrier concentrations of 10<sup>16</sup>-10<sup>19</sup> cm<sup>-3</sup> and mobilities of 0.3-16cm<sup>2</sup>V<sup>-1</sup>s<sup>-1</sup>) in comparison with polycrystalline films used as transparent conducting coatings. No anisotropy of the conductivity was noticeable in spite of the alignment of the SnO<sub>2</sub> particles along a particular crystallographic axis.*

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## Gas Pressure Sintered Silicon Nitride Containing Praseodymium Oxide as Sintering Aid

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*Pr<sub>2</sub>O<sub>3</sub> doped Si<sub>3</sub>N<sub>4</sub>, with or without simultaneous addition of other oxides were fired at 1900° - 2050°C under 1 MPa N<sub>2</sub> pressure. In Si<sub>3</sub>N<sub>4</sub> containing 15 mol% Pr<sub>2</sub>O<sub>3</sub>, it was assumed that an oxynitride having a structure similar to that of CeSiO<sub>2</sub>N is formed at grain boundaries, resulting in highly refractive ceramic without any strength degradation from room temperature to 1300°C. When sintered at above 2000°C, nearly full-dense Si<sub>3</sub>N<sub>4</sub> was obtained with 7.5 mol% Pr<sub>2</sub>O<sub>3</sub> and 7.5 mol% Y<sub>2</sub>O<sub>3</sub>. The sample, having yttrium oxynitrides as grain boundary phases, showed a strength of over 800 MPa at room temperature and of 600-700 MPa at 1300°C. Si<sub>3</sub>N<sub>4</sub> with 7.5 mol% Pr<sub>2</sub>O<sub>3</sub> and 7.5 mol% Al<sub>2</sub>O<sub>3</sub> indicated significant strength degradation at 1300°C.*

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